Logic controlled high-side power switch

Rev. 1 — 24 February 2014

Product data sheet

1. General description

The NX5P2924B is a high-side load switch which features a low ON resistance N-channel MOSFET with controlled slew rate that supports 2.5 A of continuous current. Designed for operation from 0.8 V to 5.5 V, it is used in power domain isolation applications to reduce power dissipation and extend battery life. The enable logic includes integrated logic level translation making the device compatible with lower voltage processors and controllers. The NX5P2924B is ideal for portable, battery operated applications due to low ground current.

2. Features and benefits

- Wide supply voltage range from 0.8 V to 5.5 V
- Very low ON resistance:
 - 14 mΩ (typical) at a supply voltage of 1.2 V
 - 14 mΩ (typical) at a supply voltage of 1.8 V
- High noise immunity
- High current handling capability (2.5 A continuous current)
- Turn-on slew rate limiting
- ESD protection:
 - HBM JESD22-A114F Class 3A exceeds 4000 V
 - CDM AEC-Q100-011 revision B exceeds 1000 V
- Specified from –40 °C to +85 °C

3. Applications

- Cell phone
- Digital cameras and audio devices
- Portable and battery-powered equipment



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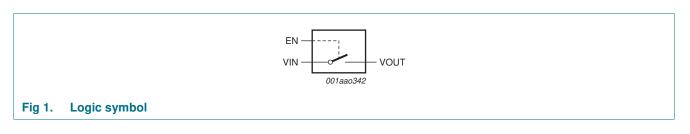
4. Ordering information

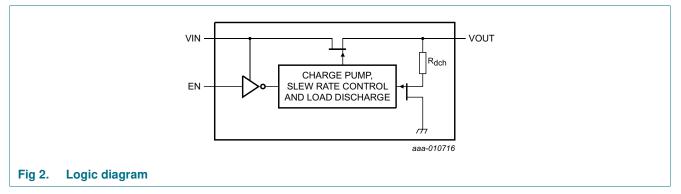
Table 1. Ordering information								
Type number Package								
	Temperature range	Name	Description	Version				
NX5P2924BUK	–40 °C to +85 °C	WLCSP6	wafer level chip-scale package; 6 bumps; 0.87 x 1.37 x 0.5 mm	NX5P2924B				

5. Marking

Table 2. Marking codes	
Type number	Marking code
NX5P2924BUK	4B

6. Functional diagram

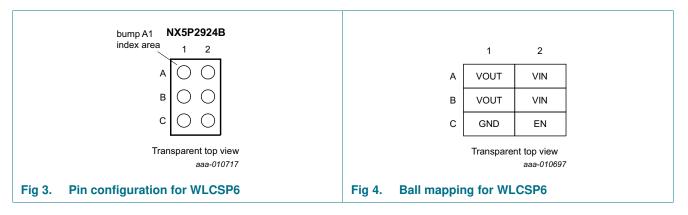




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7. Pinning information

7.1 Pinning



7.2 Pin description

Table 3.	Pin description		
Symbol		Pin	Description
VIN		A2, B2	input voltage
GND		C1	ground (0 V)
EN		C2	enable input (active HIGH)
VOUT		A1, B1	output voltage

8. Functional description

Table 4.Function table^[1]

Input EN	Switch
L	switch OFF
Н	switch ON

[1] H = HIGH voltage level; L = LOW voltage level.

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9. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
VI	input voltage	input EN	<u>[1]</u> –0.5	+6.0	V
		input VIN	[2] -0.5	+6.0	V
V _{SW}	switch voltage	output VOUT	[2] -0.5	V _{I(VIN)}	V
I _{IK}	input clamping current	input EN: $V_{I(EN)} < -0.5 V$	-50	-	mA
I _{SK}	switch clamping current	input VIN: $V_{I(VIN)} < -0.5 V$	-50	-	mA
		output VOUT: $V_{O(VOUT)} < -0.5 V$	-50	-	mA
		output VOUT: $V_{O(VOUT)} > V_{I(VIN)} + 0.5 V$	-	50	mA
I _{SW}	switch current	$V_{SW} > -0.5 V$	-	±2500	mA
T _{j(max)}	maximum junction temperature		-40	+125	°C
T _{stg}	storage temperature		-65	+150	°C
P _{tot}	total power dissipation		[3] _	470	mW

[1] The minimum input voltage rating may be exceeded if the input current rating is observed.

[2] The minimum and maximum switch voltage ratings may be exceeded if the switch clamping current rating is observed.

[3] The (absolute) maximum power dissipation depends on the junction temperature T_j. Higher power dissipation is allowed with lower ambient temperatures. The conditions to determine the specified values are T_{amb} = 85 °C and the use of a two layer PCB.

10. Recommended operating conditions

Table 6. Recommended operating conditions

Symbol	Parameter	Conditions	Min	Max	Unit
VI	input voltage		0.8	5.5	V
T _{amb}	ambient temperature		-40	+85	°C

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11. Thermal characteristics

Table 7.	Thermal characteristics			
Symbol	Parameter	Conditions	Тур	Unit
R _{th(j-a)}	thermal resistance from junction to ambient		<u>[1]</u> 139	K/W

R_{th(j-a)} is dependent upon board layout. To minimize R_{th(j-a)}, ensure that all pins have a solid connection to larger copper layer areas. In multi-layer PCBs, the second layer should be used to create a large heat spreader area below the device. Avoid using solder-stop varnish under the device.

12. Static characteristics

Table 8. Static characteristics

 $V_{I(VIN)} = 1.0 \text{ V to } 5.5 \text{ V}$, unless otherwise specified; Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Ta	_{mb} = 25	°C	T _{amb} = -40 °C	C to +85 °C	Unit
			Min	Typ <mark>[1]</mark>	Max	Min	Max	
V _{IH}	HIGH-level input	EN input; $V_{I(VIN)} = 0.8 V$	-	0.7	-	-	-	V
	voltage	EN input; $V_{I(VIN)} = 1.0$ V to 1.2 V	0.9	-	-	0.9	-	V
		EN input; $V_{I(\text{VIN})}$ = 1.2 V to 2.5 V	1.2	-	-	1.2	-	V
		EN input; $V_{I(\text{VIN})}$ = 2.5 V to 5.5 V	1.2	-	-	1.2	-	V
V _{IL}	LOW-level input	EN input; $V_{I(VIN)} = 0.8 V$	-	0.25	-	-	-	V
	voltage	EN input; $V_{I(VIN)}$ = 1.0 V to 1.2 V	-	-	0.3	-	0.3	V
		EN input; $V_{I(VIN)}$ = 1.2 V to 2.5 V	-	-	0.4	-	0.4	V
		EN input; $V_{I(VIN)}$ = 2.5 V to 5.5 V	-	-	0.6	-	0.6	V
lı	input leakage current	EN input; $V_{I(EN)} = 0.9$ V to 5.5 V	-	-	-	-	0.1	μA
R _{dch}	discharge	VOUT output; $V_{I(VIN)} = 0.8 V$	-	4.00	-	-	-	kΩ
	resistance	VOUT output; $V_{I(VIN)} = 1.0 V$	-	1.40	-	-	-	kΩ
		VOUT output; $V_{I(VIN)} = 1.2 V$	-	1.30	-	-	-	kΩ
		VOUT output; $V_{I(VIN)} = 1.8 V$	-	1.27	1.50	-	-	kΩ
		VOUT output; $V_{I(VIN)} = 3.3 V$	-	1.25	1.50	-	-	kΩ
		VOUT output; $V_{I(VIN)} = 5.5 V$	-	1.25	1.50	-	-	kΩ

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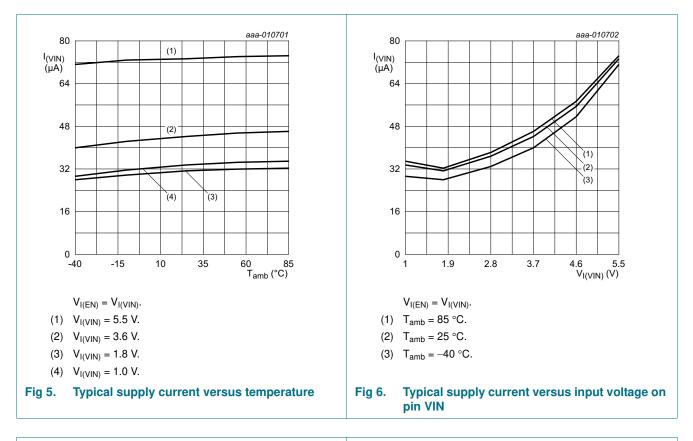
Symbol	Parameter	Conditions	Ta	_{mb} = 25	°C	T _{amb} = -40 °C	to +85 °C	Unit
			Min	Typ[1]	Max	Min	Мах	
I _(VIN)	supply current	VOUT open						•
		EN = HIGH; $V_{I(VIN)}$ = 1.0 V; see <u>Figure 5</u> and <u>Figure 6</u>	-	25	-	-	35	μA
		EN = HIGH; $V_{I(VIN)}$ = 1.8 V; see <u>Figure 5</u> and <u>Figure 6</u>	-	30	-	-	50	μA
		EN = HIGH; $V_{I(VIN)}$ = 3.6 V; see <u>Figure 5</u> and <u>Figure 6</u>	-	45	-	-	65	μA
		EN = HIGH; $V_{I(VIN)}$ = 5.5 V; see <u>Figure 5</u> and <u>Figure 6</u>	-	75	-	-	105	μA
		EN = LOW; $V_{I(VIN)}$ = 1.0 V; see <u>Figure 7</u> and <u>Figure 8</u>	-	0.1	-	-	0.8	μA
		EN = LOW; $V_{I(VIN)}$ = 1.8 V; see Figure 7 and Figure 8	-	0.1	-	-	1.0	μA
		EN = LOW; $V_{I(VIN)}$ = 3.6 V; see <u>Figure 7</u> and <u>Figure 8</u>	-	0.1	-	-	1.2	μA
		EN = LOW; $V_{I(VIN)}$ = 5.5 V; see <u>Figure 7</u> and <u>Figure 6</u>	-	0.1	-	-	1.5	μA
I _{S(OFF)}	OFF-state leakage current	$ EN = LOW; V_{I(VIN)} = 1.8 V; \\ V_{I(VOUT)} = 0 V; see Figure 9 and Figure 10 $	-	-0.5	-	-3.5	-	μA
		$ EN = LOW; V_{I(VIN)} = 3.6 V; \\ V_{I(VOUT)} = 0 V; see Figure 9 and Figure 10 $	-	-0.5	-	-5.0	-	μA
		$ EN = LOW; V_{I(VIN)} = 5.5 V; \\ V_{I(VOUT)} = 0 V; see Figure 9 and Figure 10 $	-	-0.5	-	-7.5	-	μA
Cı	input capacitance	EN	-	3	-	-	-	pF
C _{S(ON)}	ON-state capacitance	VIN; VOUT	-	-	0.5	-	0.5	nF

Table 8. Static characteristics ...continued

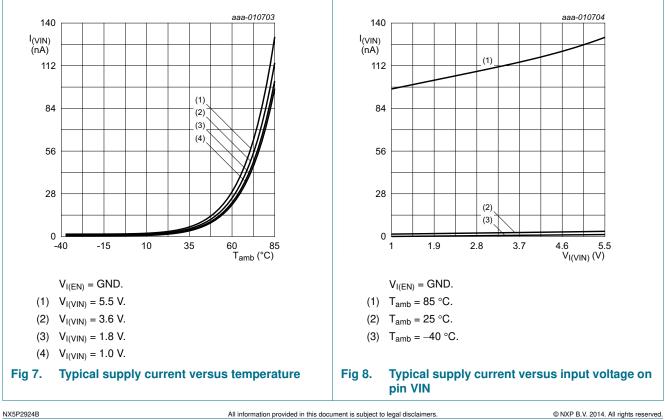
V_{I(VIN)} = 1.0 V to 5.5 V, unless otherwise specified; Voltages are referenced to GND (ground = 0 V). ...continued

[1] All typical values are measured at $V_{I(VIN)}$ = 3.6 V and T_{amb} = 25 °C unless otherwise specified.

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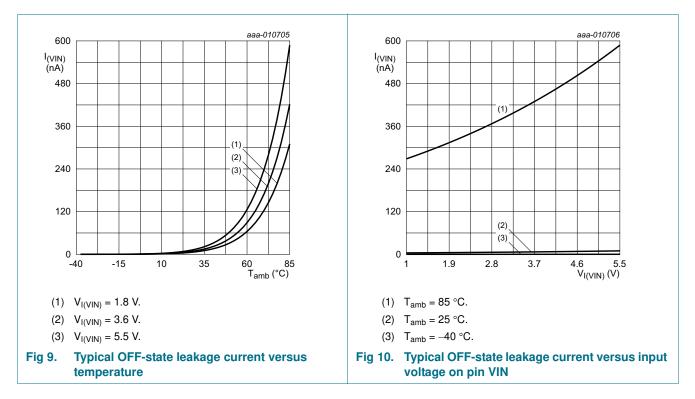


12.1 Graphs



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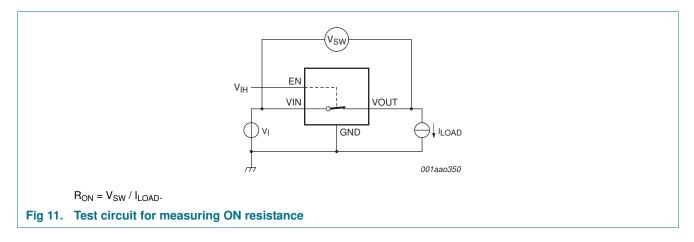
12.2 ON resistance

Table 9.ON resistance

At recommended operating conditions; voltages are referenced to GND (ground = 0 V)

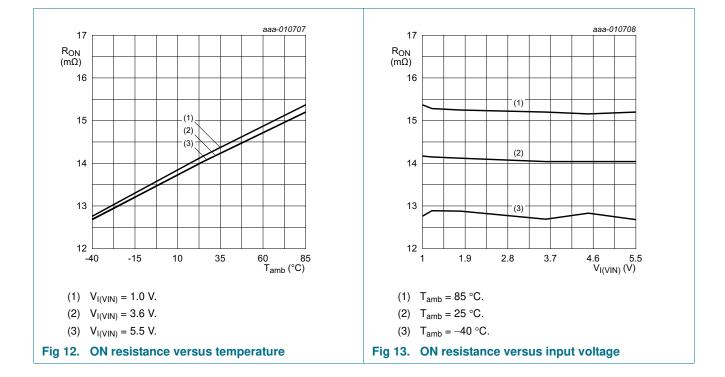
Symbol	Parameter	Conditions	T _{amb} = 25 °C		T _{amb} = -40 °C to +85 °C		Unit	
			Min	Тур	Max	Min	Мах	
R _{ON} ON resistance	$V_{I(EN)} = 1.5 \text{ V}; I_{LOAD} = 200 \text{ mA};$ see <u>Figure 11</u> , <u>12</u> and <u>13</u>							
		$V_{I(VIN)} = 0.8 \text{ V to } 5.5 \text{ V}$	-	14	-	-	20	mΩ

12.3 ON resistance test circuit and graphs



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13. Dynamic characteristics

Table 10. Dynamic characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V); for test circuit, see Figure 15.

Symbol	Parameter	Conditions	Ta	amb = 25	°C	T _{amb} = -40 °C	C to +85 °C	Unit
			Min	Тур	Max	Min	Max	
t _{en} ena	enable time	EN to VOUT; see <u>Figure 14</u> , <u>16, 17</u> , <u>18</u> and <u>20</u>					'	
		$V_{I(VIN)} = 0.8 V$	-	600	-	-	-	μS
		$V_{I(VIN)} = 1.0 V$	-	240	-	-	-	μS
		$V_{I(VIN)} = 3.6 V$	-	90	-	-	-	μS
		$V_{I(VIN)} = 5.5 V$	-	90	-	-	-	μS
t _{dis}	disable time	EN to VOUT; see <u>Figure 14,</u> <u>19</u> and <u>21</u>						
		$V_{I(VIN)} = 0.8 V$	-	210	-	-	-	μS
		$V_{I(VIN)} = 1.0 V$	-	20	-	-	-	μS
		$V_{I(VIN)} = 3.6 V$	-	5	-	-	-	μS
		$V_{I(VIN)} = 5.5 V$	-	4	-	-	-	μS
t _{on} turn-on time	turn-on time	EN to VOUT; see <u>Figure 14,</u> <u>16, 17, 18</u> and <u>20</u>						
		$V_{I(VIN)} = 0.8 V$	-	1000	-	-	-	μS
		$V_{I(VIN)} = 1.0 V$	-	350	-	-	-	μS
		$V_{I(VIN)} = 3.6 V$	-	240	-	-	-	μS
		$V_{I(VIN)} = 5.5 V$	-	290	-	-	-	μS
t _{off}	turn-off time	EN to VOUT; see <u>Figure 14,</u> <u>19</u> and <u>21</u>						μS
		$V_{I(VIN)} = 0.8 V$	-	220.0	-	-	-	μS
		$V_{I(VIN)} = 1.0 V$	-	22.3	-	-	-	μS
		$V_{I(VIN)} = 3.6 V$	-	7.2	-	-	-	μS
		$V_{I(VIN)} = 5.5 V$	-	6.0	-	-	-	μS
TLH	LOW to HIGH	VOUT; see Figure 14						
	output transition time	$V_{I(VIN)} = 0.8 V$	-	400	-	-	-	μS
		$V_{I(VIN)} = 1.0 V$	-	110	-	20	-	μS
		$V_{I(VIN)} = 3.6 V$	-	150	-	50	-	μS
		$V_{I(VIN)} = 5.5 V$	-	200	-	70	-	μS
^t τнl	HIGH to LOW	VOUT; see Figure 14						
	output transition time	$V_{I(VIN)} = 0.8 V$	-	10.0	-	-	-	μS
		$V_{I(VIN)} = 1.0 V$	-	2.3	-	-	-	μS
		$V_{I(VIN)} = 3.6 V$	-	2.2	-	-	-	μS
		$V_{I(VIN)} = 5.5 V$	-	2.0	-	-	-	μS

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13.1 Waveforms, graphs and test circuit

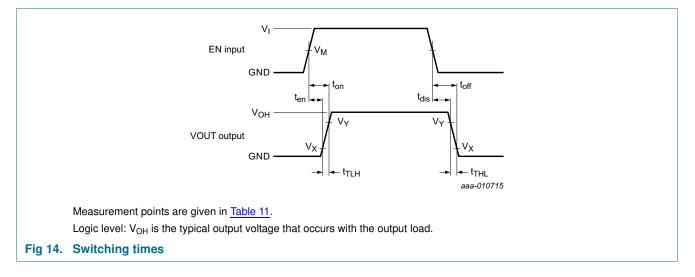


Table 11. Measurement points

Supply voltage	EN Input	Output			
V _{I(VIN)}	V _M	V _X	V _Y		
1.0 V to 5.5 V	$0.5 \times V_{I(EN)}$	$0.1 \times V_{OH}$	$0.9 \times V_{OH}$		

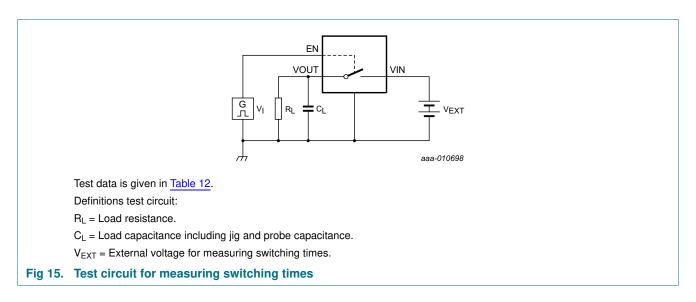


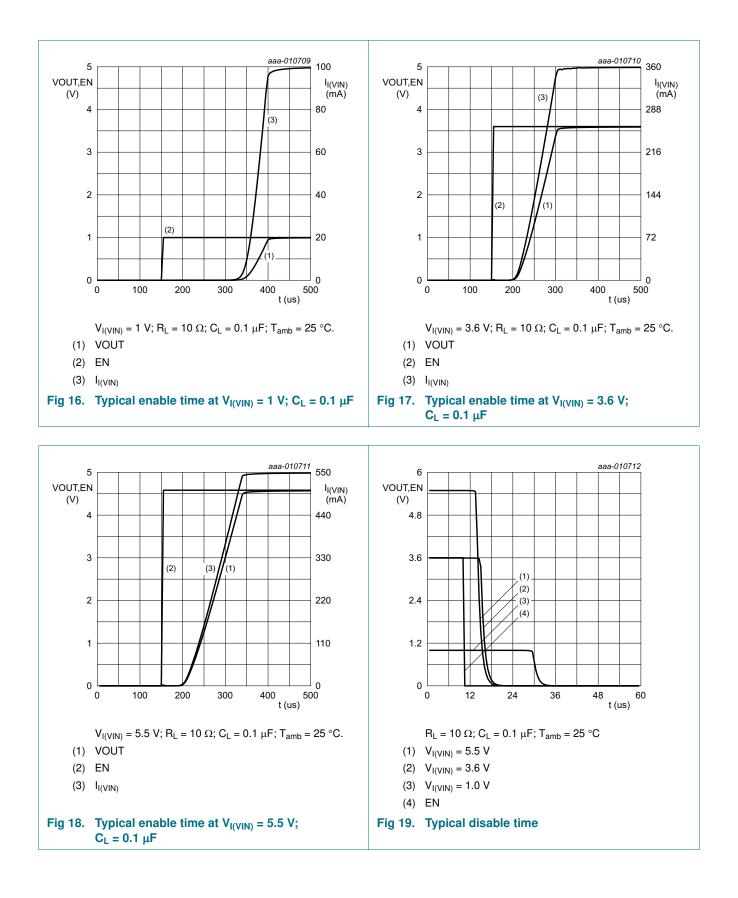
Table 12. Test data

Supply voltage	Input	Load	
V _{EXT}	V _{I(EN)}	CL	RL
1.0 V to 5.5 V	1.5 V	0.1 μF	10 Ω

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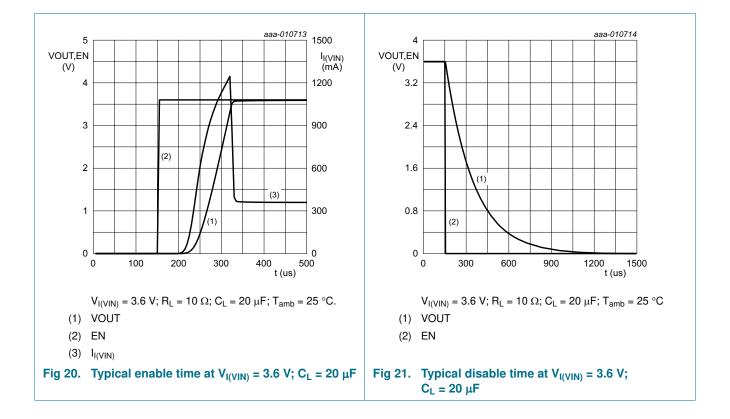
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14. Package outline

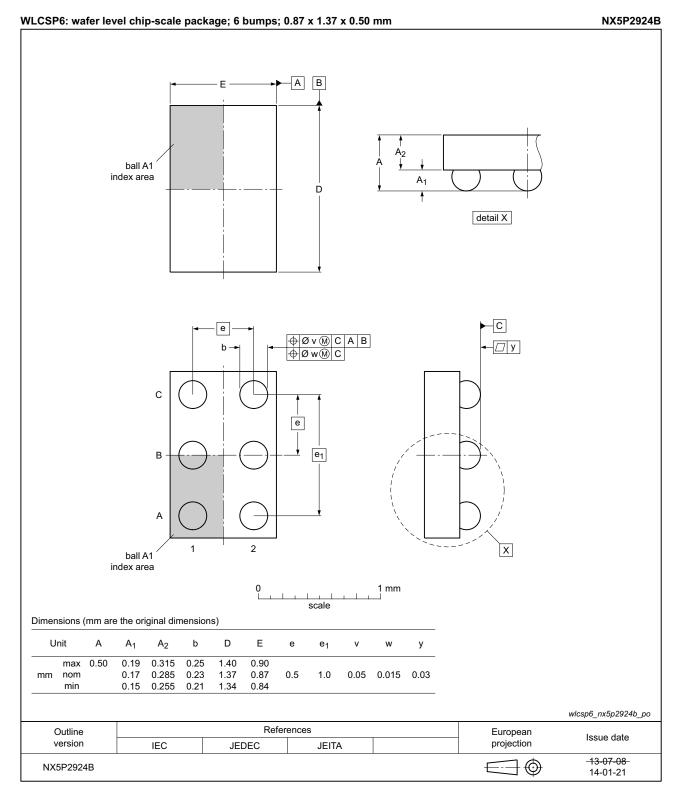


Fig 22. Package outline NX5P2924B

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15. Abbreviations

Table 13. Abbreviations				
Acronym	Description			
CDM	Charged Device Model			
DUT	Device Under Test			
ESD	ElectroStatic Discharge			
HBM	Human Body Model			
IEC	International Electrotechnical Commission			
MOSFET	Metal-Oxide Semiconductor Field Effect Transistor			

16. Revision history

Table 14. Revision history					
Document ID	Release date	Data sheet status	Change notice	Supersedes	
NX5P2924B v.1	20140224	Product data sheet	-	-	

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17. Legal information

17.1 Data sheet status

Document status[1][2]	Product status ^[3]	Definition
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